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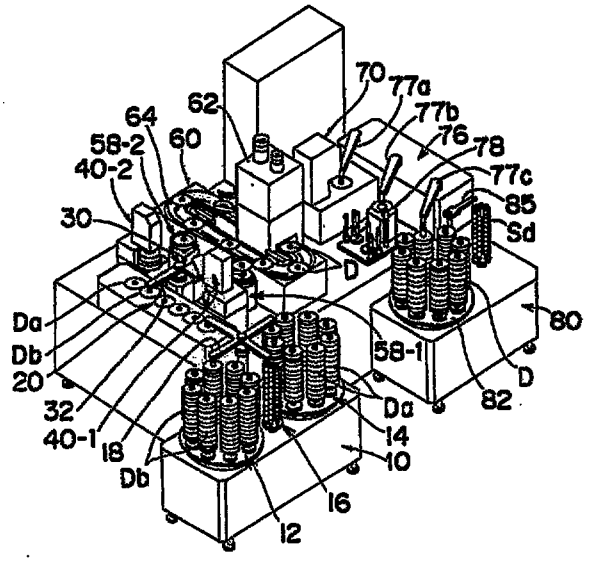
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(54) Title: METHOD AND APPARATUS FOR MANUFACTURING OPTICAL DISK



(57) Abstract

Substrates to be paired are alternately aligned, one substrate of a pair of substrates adjacent to each other is turned over thereby to be faced to the other substrate, substrates caught in a state faced to each other are sent to a bond position, and adhesive is supplied annularly into an interval of the substrates, the substrates are rotated in a plane direction thereby to narrow the interval and eventually spread the adhesive in a radial direction to form an adhesive layer, the lower substrate is supported from below and carried from the bond position to a set position, the adhesive layer is set, whereby an optical disk is obtained, the optical disk is taken out from the set position.